# BF904A; BF904AR; BF904AWR

# N-channel dual gate MOS-FETs

Rev. 04 — 13 November 2007

**Product data sheet** 

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**NXP Semiconductors** 



# N-channel dual gate MOS-FETs

### BF904A; BF904AR; BF904AWR

#### **FEATURES**

- Specially designed for use at 5 V supply voltage
- Short channel transistor with high transfer admittance to input capacitance ratio
- Low noise gain controlled amplifier up to 1 GHz
- Superior cross-modulation performance during AGC.

#### **APPLICATIONS**

 VHF and UHF applications with 3 to 7 V supply voltage such as television tuners and professional communications equipment.

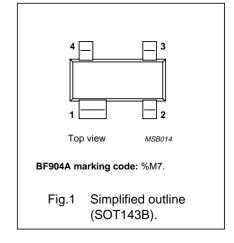
### **DESCRIPTION**

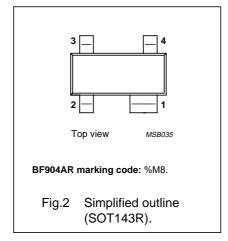
Enhancement type field-effect transistors. The transistors consist of an amplifier MOS-FET with source and substrate interconnected and an internal bias circuit to ensure good cross-modulation performance during AGC.

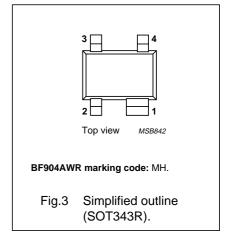
The BF904A, BF904AR and BF904AWR are encapsulated in the SOT143B, SOT143R and SOT343R plastic packages respectively.

#### **PINNING**

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | source      |
| 2   | drain       |
| 3   | gate 2      |
| 4   | gate 1      |







#### QUICK REFERENCE DATA

| SYMBOL              | PARAMETER                      | CONDITIONS              | MIN. | TYP. | MAX. | UNIT |
|---------------------|--------------------------------|-------------------------|------|------|------|------|
| V <sub>DS</sub>     | drain-source voltage           |                         | _    | _    | 7    | ٧    |
| I <sub>D</sub>      | drain current                  |                         | _    | _    | 30   | mA   |
| P <sub>tot</sub>    | total power dissipation        | T <sub>s</sub> ≤ 110 °C | _    | _    | 200  | mW   |
| y <sub>fs</sub>     | forward transfer admittance    |                         | 22   | 25   | 30   | mS   |
| C <sub>ig1-ss</sub> | input capacitance at gate 1    |                         | _    | 2.2  | 2.6  | pF   |
| C <sub>rss</sub>    | reverse transfer capacitance   | f = 1 MHz               | _    | 25   | 35   | fF   |
| F                   | noise figure                   | f = 800 MHz             | _    | 2    | _    | dB   |
| T <sub>i</sub>      | operating junction temperature |                         | _    | _    | 150  | °C   |

### **CAUTION**

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

# N-channel dual gate MOS-FETs

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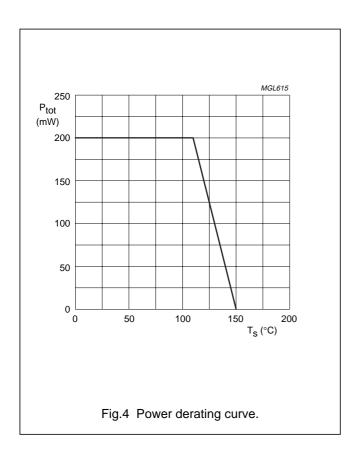
### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL           | PARAMETER                      | CONDITIONS                                 | MIN. | MAX. | UNIT |
|------------------|--------------------------------|--|------|------|------|
| V <sub>DS</sub>  | drain-source voltage           |  | _    | 7    | ٧    |
| I <sub>D</sub>   | drain current                  |  | _    | 30   | mA   |
| I <sub>G1</sub>  | gate 1 current                 |  | _    | ±10  | mA   |
| I <sub>G2</sub>  | gate 2 current                 |  | _    | ±10  | mA   |
| P <sub>tot</sub> | total power dissipation        | T <sub>s</sub> ≤ 110 °C; note 1; see Fig.4 | _    | 200  | mW   |
| T <sub>stg</sub> | storage temperature            |  | -65  | +150 | °C   |
| Tj               | operating junction temperature |  | _    | 150  | °C   |

### Note

1.  $T_s$  is the temperature of the soldering point of the source lead.



### N-channel dual gate MOS-FETs

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### THERMAL CHARACTERISTICS

| SYMBOL              | PARAMETER   | CONDITIONS | VALUE | UNIT |
|---------------------|---|------------|-------|------|
| R <sub>th j-s</sub> | thermal resistance from junction to soldering point | note 1     | 200   | K/W  |

#### Note

1. Soldering point of the source lead.

### STATIC CHARACTERISTICS

 $T_j = 25$  °C unless otherwise specified.

| SYMBOL                 | PARAMETER                       | CONDITIONS  | MIN. | MAX. | UNIT |
|------------------------|---------------------------------|---|------|------|------|
| V <sub>(BR)G1-SS</sub> | gate 1-source breakdown voltage | $V_{G2-S} = V_{DS} = 0$ ; $I_{G1-S} = 10 \text{ mA}$  | 6    | 15   | V    |
| V <sub>(BR)G2-SS</sub> | gate 2-source breakdown voltage | $V_{G1-S} = V_{DS} = 0$ ; $I_{G2-S} = 10 \text{ mA}$  | 6    | 15   | V    |
| V <sub>(F)S-G1</sub>   | forward source-gate 1 voltage   | $V_{G2-S} = V_{DS} = 0$ ; $I_{S-G1} = 10 \text{ mA}$  | 0.5  | 1.5  | V    |
| V <sub>(F)S-G2</sub>   | forward source-gate 2 voltage   | $V_{G1-S} = V_{DS} = 0$ ; $I_{S-G2} = 10 \text{ mA}$  | 0.5  | 1.5  | V    |
| V <sub>G1-S(th)</sub>  | gate 1-source threshold voltage | $V_{G2-S} = 4 \text{ V}; V_{DS} = 5 \text{ V}; I_D = 20 \mu\text{A}$                              | 0.3  | 1    | V    |
| V <sub>G2-S(th)</sub>  | gate 2-source threshold voltage | $V_{G1-S} = V_{DS} = 5 \text{ V}; I_D = 20 \mu\text{A}$   | 0.3  | 1.2  | V    |
| I <sub>DSX</sub>       | drain-source current            | $V_{G2-S} = 4 \text{ V}; V_{DS} = 5 \text{ V};$<br>$R_{G1} = 120 \text{ k}\Omega; \text{ note 1}$ | 8    | 13   | mA   |
| I <sub>G1-SS</sub>     | gate 1 cut-off current          | $V_{G2-S} = V_{DS} = 0; V_{G1-S} = 5 \text{ V}$   | _    | 50   | nA   |
| I <sub>G2-SS</sub>     | gate 2 cut-off current          | $V_{G1-S} = V_{DS} = 0; V_{G2-S} = 5 \text{ V}$   | _    | 50   | nA   |

#### Note

1.  $R_{G1}$  connects gate 1 to  $V_{GG} = 5$  V; see Fig.21.

### **DYNAMIC CHARACTERISTICS**

Common source;  $T_{amb}$  = 25 °C;  $V_{DS}$  = 5 V;  $V_{G2-S}$  = 4 V;  $I_D$  = 10 mA; unless otherwise specified.

| SYMBOL             | PARAMETER                    | CONDITIONS  | MIN. | TYP. | MAX. | UNIT |
|--------------------|------------------------------|---|------|------|------|------|
| y <sub>fs</sub>    | forward transfer admittance  | pulsed; T <sub>j</sub> = 25 °C                              | 22   | 25   | 30   | mS   |
| C <sub>ig1-s</sub> | input capacitance at gate 1  | f = 1 MHz   | _    | 2.2  | 2.6  | pF   |
| C <sub>ig2-s</sub> | input capacitance at gate 2  | f = 1 MHz   | 1    | 1.5  | 2    | pF   |
| C <sub>os</sub>    | drain-source capacitance     | f = 1 MHz   | 1    | 1.4  | 1.7  | pF   |
| C <sub>rs</sub>    | reverse transfer capacitance | f = 1 MHz   | _    | 25   | 35   | fF   |
| F                  | noise figure                 | $f = 200 \text{ MHz}; G_S = 2 \text{ mS}; B_S = B_{Sopt}$   | _    | 1    | 1.5  | dB   |
|                    |                              | $f = 800 \text{ MHz}$ ; $G_S = G_{Sopt}$ ; $B_S = B_{Sopt}$ | _    | 2    | 2.8  | dB   |

# N-channel dual gate MOS-FETs

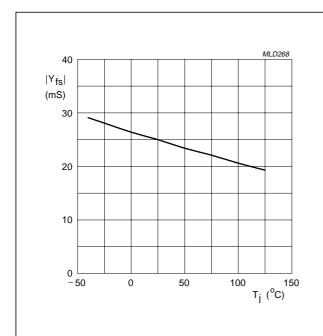
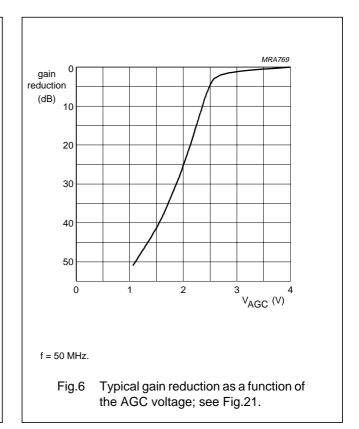
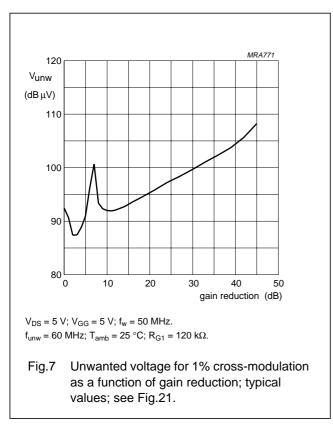
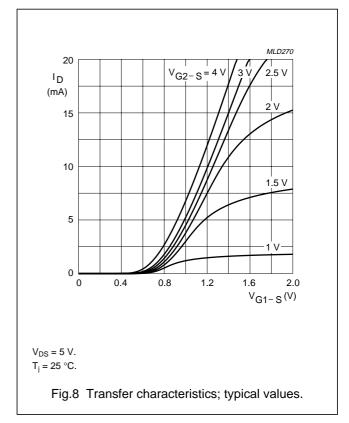


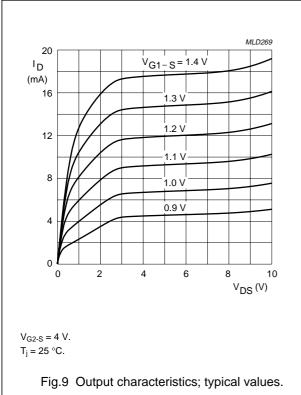
Fig.5 Transfer admittance as a function of the junction temperature; typical values.

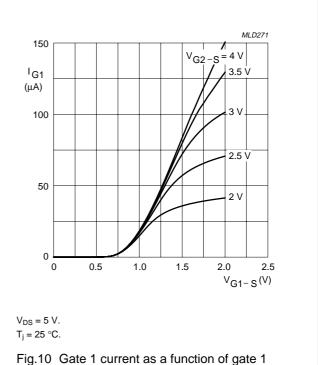


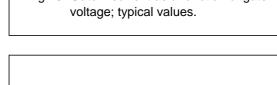


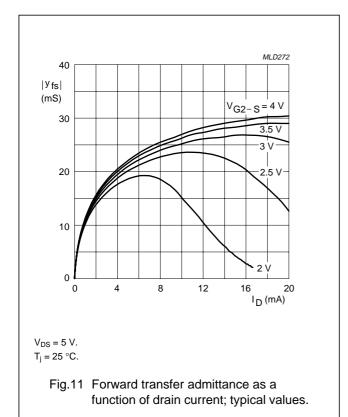


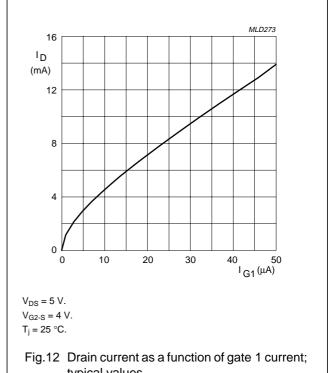
# N-channel dual gate MOS-FETs





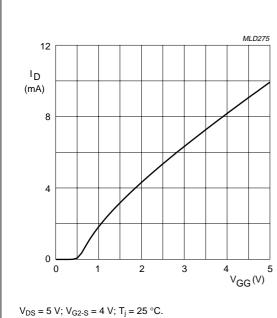






# N-channel dual gate MOS-FETs

### BF904A; BF904AR; BF904AWR



 $V_{DS} = 5 \text{ V}$ ;  $V_{G2-S} = 4 \text{ V}$ ;  $I_j = 25 \text{ °C}$ .  $R_{G1} = 120 \text{ k}\Omega$  (connected to  $V_{GG}$ ); see Fig.21.

Fig.13 Drain current as a function of gate 1 supply voltage (= V<sub>GG</sub>); typical values.

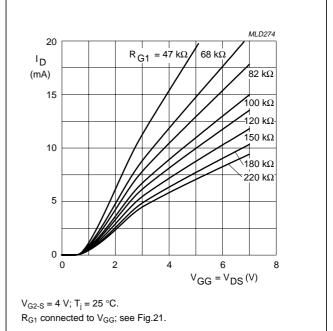


Fig.14 Drain current as a function of gate 1 (= V<sub>GG</sub>) and drain supply voltage; typical values.

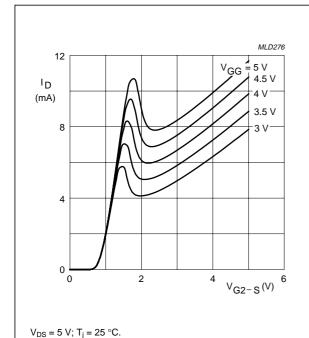
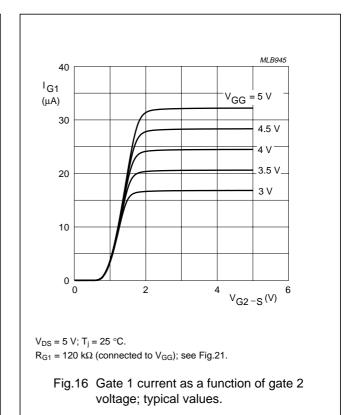


Fig.15 Drain current as a function of gate 2 voltage; typical values.

 $R_{G1}$  = 120 k $\Omega$  (connected to  $V_{GG}$ ); see Fig.21.



# N-channel dual gate MOS-FETs

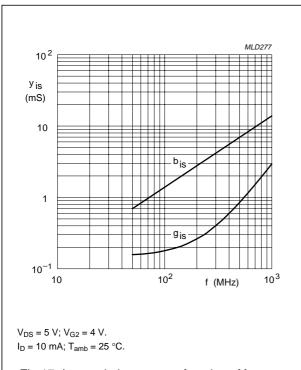


Fig.17 Input admittance as a function of frequency; typical values.

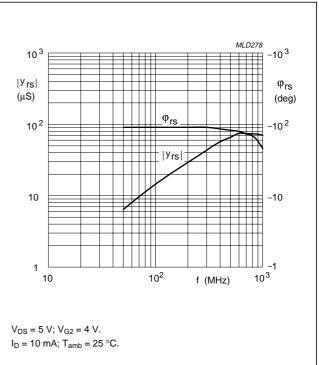


Fig.18 Reverse transfer admittance and phase as a function of frequency; typical values.

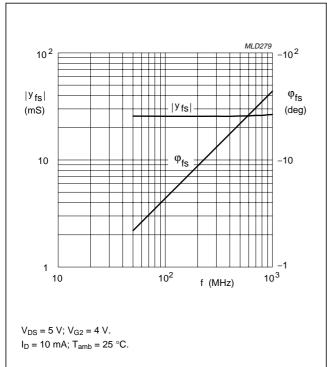
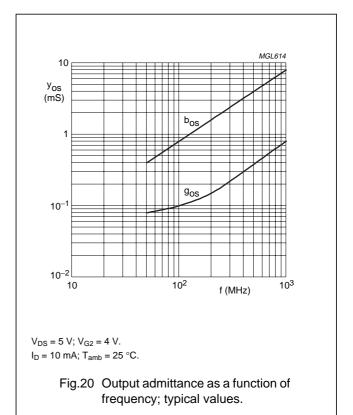
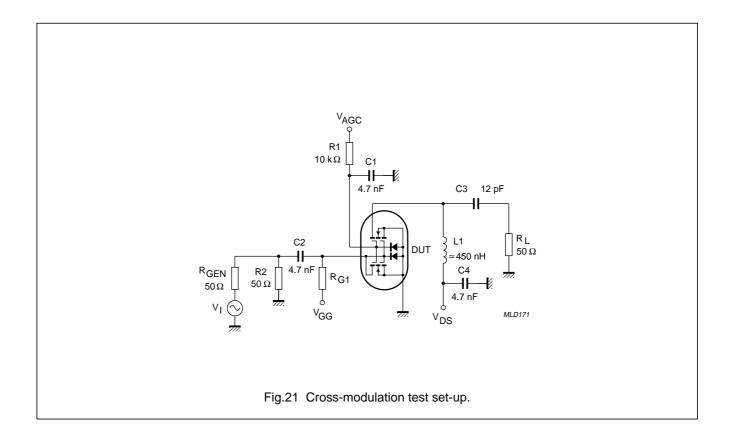


Fig.19 Forward transfer admittance and phase as a function of frequency; typical values.



# N-channel dual gate MOS-FETs



# N-channel dual gate MOS-FETs

**Table 1** Scattering parameters:  $V_{DS}$  = 5 V;  $V_{G2-S}$  = 4 V;  $I_D$  = 10 mA;  $T_{amb}$  = 25 °C

| f     | S <sub>11</sub>   |             | S <sub>21</sub>               |        | S <sub>12</sub>               |       | S <sub>22</sub>   |             |
|-------|-------------------|-------------|-------------------------------|--------|-------------------------------|-------|-------------------|-------------|
| (MHz) | MAGNITUDE (ratio) | ANGLE (deg) | MAGNITUDE ANGLE (ratio) (deg) |        | MAGNITUDE ANGLE (ratio) (deg) |       | MAGNITUDE (ratio) | ANGLE (deg) |
| 40    | 0.989             | -3.2        | 2.52                          | 175.9  | 0.001                         | 87.9  | 0.989             | -1.7        |
| 100   | 0.987             | -7.9        | 2.52                          | 169.4  | 0.001                         | 86.1  | 0.988             | -4.3        |
| 200   | 0.976             | -15.7       | 2.47                          | 159.2  | 0.003                         | 81.4  | 0.984             | -8.6        |
| 300   | 0.972             | -23.3       | 2.43                          | 150.5  | 0.004                         | 80.5  | 0.985             | -12.7       |
| 400   | 0.947             | -30.6       | 2.36                          | 139.6  | 0.005                         | 76.9  | 0.975             | -16.9       |
| 500   | 0.925             | -37.6       | 2.26                          | 130.3  | 0.005                         | 75.6  | 0.968             | -20.8       |
| 600   | 0.905             | -44.4       | 2.19                          | 121.1  | 0.005                         | 75.5  | 0.961             | -24.7       |
| 700   | 0.883             | -50.9       | 2.10                          | 112.3  | 0.006                         | 78.0  | 0.954             | -28.4       |
| 800   | 0.861             | -57.0       | 2.01                          | 103.6  | 0.006                         | 85.3  | 0.946             | -32.0       |
| 900   | 0.841             | -63.0       | 1.93                          | 95.5   | 0.006                         | 90.7  | 0.934             | -35.6       |
| 1000  | 0.822             | -68.4       | 1.85                          | 87.8   | 0.006                         | 102.6 | 0.931             | -39.3       |
| 1200  | 0.787             | -78.9       | 1.71                          | 72.3   | 0.007                         | 127.1 | 0.923             | -46.7       |
| 1400  | 0.752             | -88.1       | 1.59                          | 57.3   | 0.011                         | 143.7 | 0.926             | -54.2       |
| 1600  | 0.723             | -97.3       | 1.47                          | 40.1   | 0.019                         | 150.0 | 0.935             | -62.2       |
| 1800  | 0.685             | -106.3      | 1.36                          | 25.0   | 0.021                         | 149.4 | 0.931             | -69.3       |
| 2000  | 0.665             | -114.0      | 1.31                          | 7.7    | 0.026                         | 151.5 | 0.930             | -77.7       |
| 2200  | 0.659             | -119.8      | 1.30                          | -14.0  | 0.035                         | 158.2 | 0.944             | -89.1       |
| 2400  | 0.670             | -124.2      | 1.26                          | -42.2  | 0.050                         | 163.4 | 0.941             | -103.5      |
| 2600  | 0.700             | -129.3      | 1.10                          | -78.2  | 0.076                         | 162.2 | 0.849             | -119.7      |
| 2800  | 0.729             | -138.7      | 0.82                          | -120.8 | 0.106                         | 150.5 | 0.642             | -130.9      |
| 3000  | 0.726             | -150.1      | 0.52                          | -162.8 | 0.128                         | 137.4 | 0.480             | -130.6      |

**Table 2** Noise data:  $V_{DS}$  = 5 V;  $V_{G2\text{-}S}$  = 4 V;  $I_D$  = 10 mA;  $T_{amb}$  = 25 °C

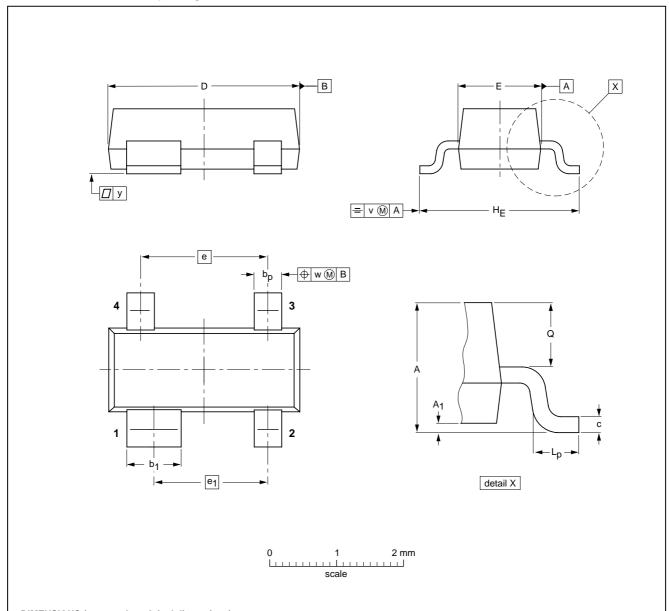
| f     | F <sub>min</sub> | Γ       | opt   | R <sub>n</sub>      |
|-------|------------------|---------|-------|---------------------|
| (MHz) | (dB)             | (ratio) | (deg) | <b>(</b> Ω <b>)</b> |
| 800   | 2.0              | 0.686   | 49.6  | 50.4                |

# BF904A; BF904AR; BF904AWR

### **PACKAGE OUTLINES**

### Plastic surface mounted package; 4 leads

SOT143B



### DIMENSIONS (mm are the original dimensions)

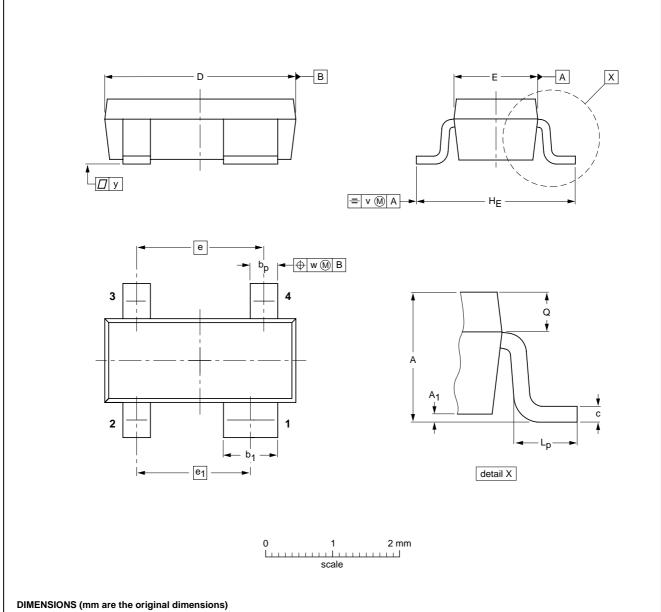
| UNIT | A          | A <sub>1</sub><br>max | bp           | b <sub>1</sub> | С            | D          | E          | е   | e <sub>1</sub> | HE         | L <sub>p</sub> | Q            | v   | w   | у   |
|------|------------|-----------------------|--------------|----------------|--------------|------------|------------|-----|----------------|------------|----------------|--------------|-----|-----|-----|
| mm   | 1.1<br>0.9 | 0.1                   | 0.48<br>0.38 | 0.88<br>0.78   | 0.15<br>0.09 | 3.0<br>2.8 | 1.4<br>1.2 | 1.9 | 1.7            | 2.5<br>2.1 | 0.45<br>0.15   | 0.55<br>0.45 | 0.2 | 0.1 | 0.1 |

| OUTLINE |     | REFER | ENCES | EUROPEAN   | ISSUE DATE |
|---------|-----|-------|-------|------------|------------|
| VERSION | IEC | JEDEC | EIAJ  | PROJECTION | ISSUE DATE |
| SOT143B |     |       |       |            | 97-02-28   |

# BF904A; BF904AR; BF904AWR

### Plastic surface mounted package; reverse pinning; 4 leads

### SOT143R



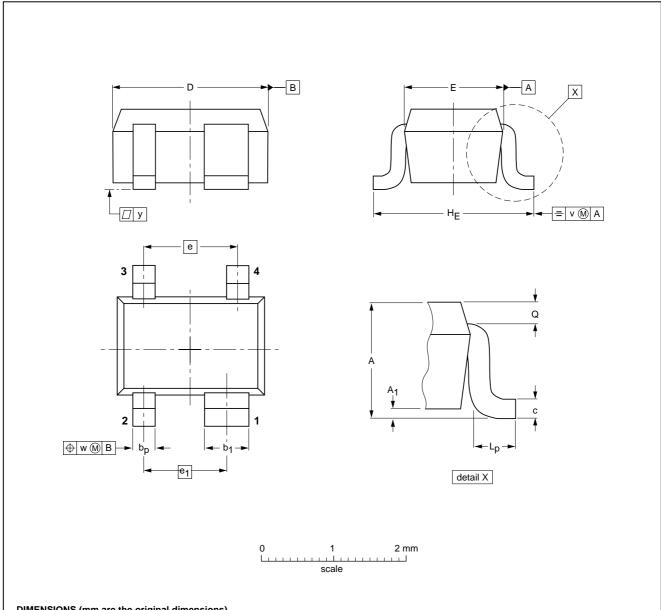
| UNIT | A          | A <sub>1</sub><br>max | bp           | b <sub>1</sub> | С            | D          | E          | е   | e <sub>1</sub> | HE         | L <sub>p</sub> | Q            | v   | w   | у   |
|------|------------|-----------------------|--------------|----------------|--------------|------------|------------|-----|----------------|------------|----------------|--------------|-----|-----|-----|
| mm   | 1.1<br>0.9 | 0.1                   | 0.48<br>0.38 | 0.88<br>0.78   | 0.15<br>0.09 | 3.0<br>2.8 | 1.4<br>1.2 | 1.9 | 1.7            | 2.5<br>2.1 | 0.55<br>0.25   | 0.45<br>0.25 | 0.2 | 0.1 | 0.1 |

| OUTLINE |     | REFER | ENCES | EUROPEAN   | ISSUE DATE |
|---------|-----|-------|-------|------------|------------|
| VERSION | IEC | JEDEC | EIAJ  | PROJECTION | ISSUE DATE |
| SOT143R |     |       |       |            | 97-03-10   |

# BF904A; BF904AR; BF904AWR

### Plastic surface mounted package; reverse pinning; 4 leads

### SOT343R



### DIMENSIONS (mm are the original dimensions)

| UNI | ТА         | A <sub>1</sub><br>max | bp         | b <sub>1</sub> | С            | D          | E            | е   | e <sub>1</sub> | HE         | Lp           | Q            | v   | w   | у   |
|-----|------------|-----------------------|------------|----------------|--------------|------------|--------------|-----|----------------|------------|--------------|--------------|-----|-----|-----|
| mn  | 1.1<br>0.8 | 0.1                   | 0.4<br>0.3 | 0.7<br>0.5     | 0.25<br>0.10 | 2.2<br>1.8 | 1.35<br>1.15 | 1.3 | 1.15           | 2.2<br>2.0 | 0.45<br>0.15 | 0.23<br>0.13 | 0.2 | 0.2 | 0.1 |

| OUTLINE |     | REFER | EUROPEAN | ISSUE DATE |            |            |  |
|---------|-----|-------|----------|------------|------------|------------|--|
| VERSION | IEC | JEDEC | EIAJ     |            | PROJECTION | ISSUE DATE |  |
| SOT343R |     |       |          |            |            | 97-05-21   |  |

# **BF904A**; **BF904AR**; **BF904AWR**

N-channel dual gate MOS-FETs

### Legal information

### **Data sheet status**

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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# **Revision history**

### **Revision history**

| Document ID                           | Release date                     | Data sheet status             | Change notice | Supersedes        |  |
|---------------------------------------|----------------------------------|-------------------------------|---------------|-------------------|--|
| BF904A_AR_AWR_N_4                     | 20071113                         | Product data sheet            | -             | BF904A_AR_AWR_3   |  |
| Modifications:                        | <ul> <li>Fig. 1 and 2</li> </ul> | on page 2; Figure note change | ed            |                   |  |
| BF904A_AR_AWR_3<br>(9397 750 05271)   | 19990514                         | Product specification         | -             | BF904A_AR_AWR_N_2 |  |
| BF904A_AR_AWR_N_2<br>(9397 750 05234) | 19990201                         | Preliminary specification     | -             | BF904A_AR_AWR_N_1 |  |
| BF904A_AR_AWR_N_1<br>(9397 750 04748) | 19981130                         | Preliminary specification     | -             | -                 |  |

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